TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

2SK2661

Chopper Regulator, DC–DC Converter and Motor Drive Applications

• Low drain–source ON resistance : RDS (ON) = 1.35 Ω (typ.)

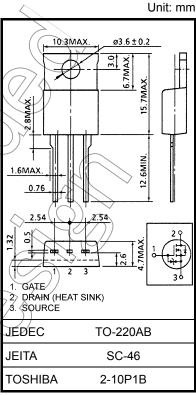
• High forward transfer admittance $: |Y_{fs}| = 4.0 \text{ S (typ.)}$

• Low leakage current : $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 500 \text{ V)}$

• Enhancement mode : $V_{th} = 2.0 \text{ to } 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteris	etics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	500	(V)
Drain-gate voltage (Ro	$_{\rm SS}$ = 20 k Ω)	V_{DGR}	500	y
Gate-source voltage		V_{GSS}	±30	V
Drain current	DC (Note 1)	ID	5	A
	Pulse (Note 1)	I _{DP}	20	Α
Drain power dissipation	r (Tc = 25°C)	P _D	75	W
Single pulse avalanche	energy (Note 2)	EAS	180	mJ
Avalanche current		I _{AR})) 5	Α
Repetitive avalanche e	nergy (Note 3)	EAR	7.5	mJ
Channel temperature		T _{ch}	150	7,¢
Storage temperature ra	inge	√\stg	-55 to 450	√°C
				,



Weight: 2.0 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

	< 4 l		
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	1.67	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.3	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 12.2 mH, R_G = 25 Ω , I_{AR} = 5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	/	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_	_	V
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) >-	4.0	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.5 A	<u> </u>	1.35	1.50	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.5	4.0	_	S
Input capacitano	ce	C _{iss}		_	780	_	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	60	_	pF
Output capacita	nce	Coss		_	200		
Switching time	Rise time	t _r	V_{GS} V_{OV} V_{OUT} V_{OUT} V_{OUT} V_{DD} V_{DD}	- (12	\ 	- ns
	Turn-on time	t _{on}			25) —	
	Fall time	t _f		7	15	_	
	Turn-off time	t _{off}	Duty ≤1%, t _w =10μs) -	60	_	
Total gate charg plus gate–drain)		Qg		_	17	_	
Gate-source ch	arge	Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, V_{D} = 5 \text{ A}$	_	11	_	nC
Gate-drain ("mil	ller") Charge	Q _{gd}		_	6	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	1 _{DR}		_	_	5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	-	_	_	20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V		1400	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} / dt = 100 A / μs	_	9	_	μC

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Marking

K2661 Part No. (or abbreviation code)
Lot No.

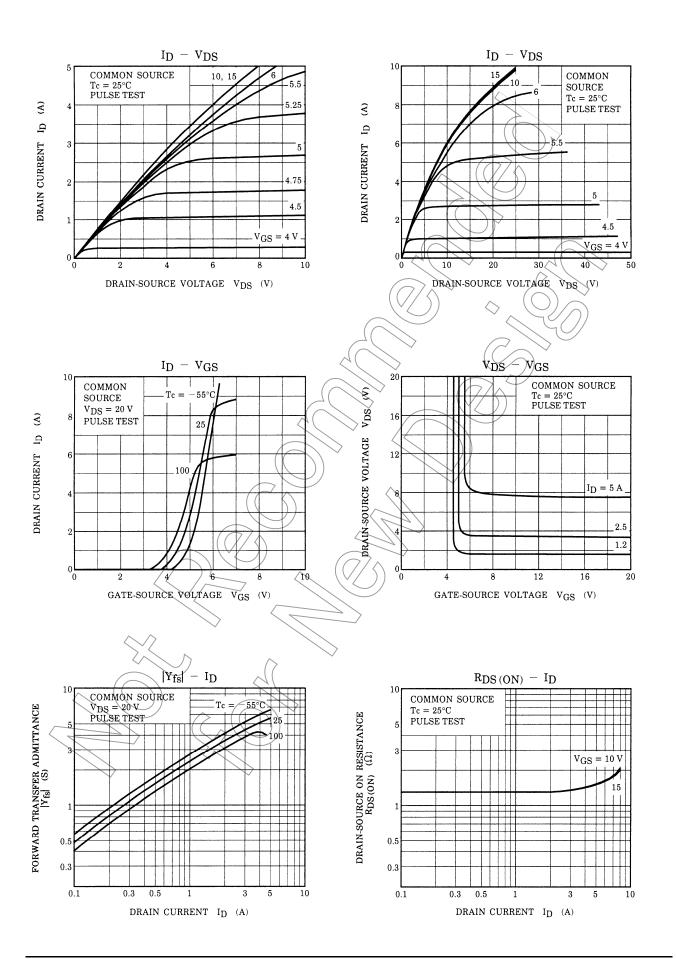
Note 4

Note 4: A line under a Lot No. identifies the indication of product Labels.

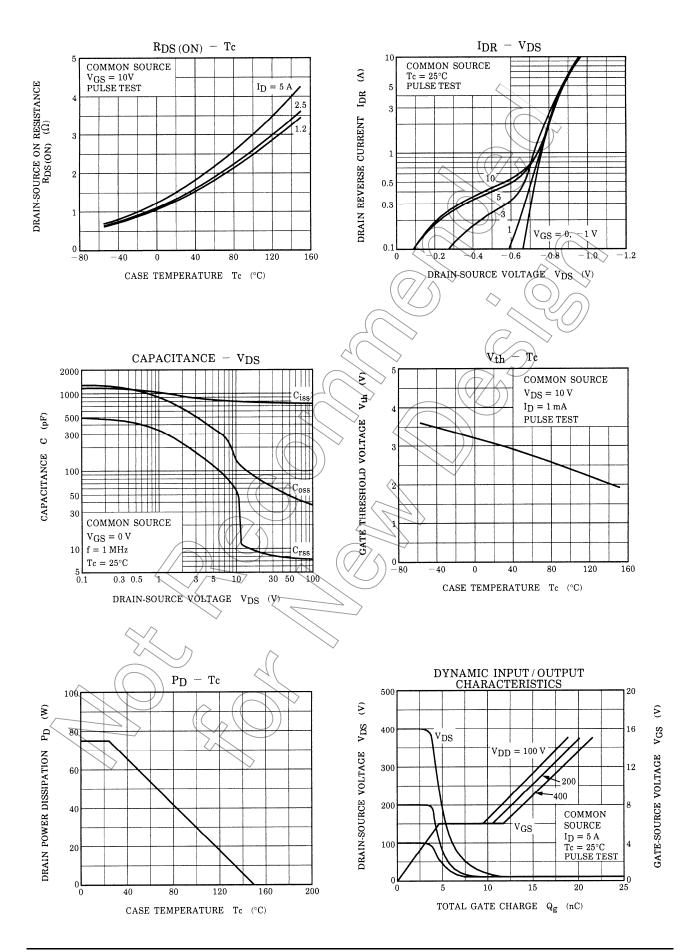
Not underlined: [[Pb]]/INCLUDES > MCV

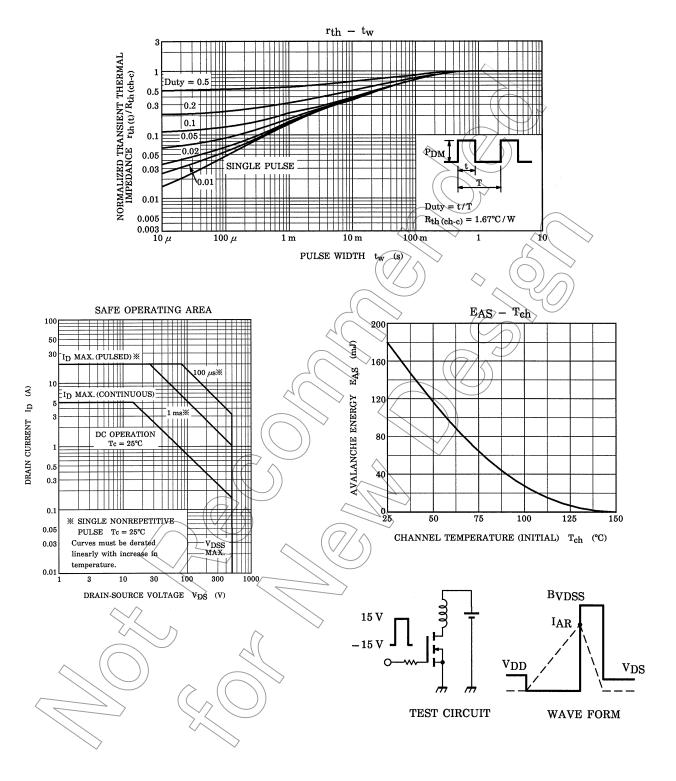
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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$$\begin{aligned} &R_G = 25~\Omega \\ &V_{DD} = 90~V,~L = 12.2~mH \end{aligned} \quad E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right) \end{aligned}$$

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